

Military 5.0V pASIC 1 Family



Military 5.0V pASIC 1 Family - Very-High-Speed CMOS FPGA

DEVICE HIGHLIGHTS

Very High Speed

- ViaLink™ metal-to-metal programmable technology, allows counter speeds over 150 MHz and logic cell delays of under 2 ns at 5V, and over 80 MHz at 3.3V operation.

High Usable Density

- Up to a 24-by-32 array of 768 logic cells provides 22,000 usable PLD gates in 208-pin PQFP and 208-pin CQFP packages.

PCI-Output Drive

- Fully PCI 2.1 compliant input/output capability. (including drive current)

FEATURES

- Total of 180 I/O pins
 - -172 Bidirectional Input/Output pins
 - -6 Dedicated Input/High-Drive pins
 - -2 Clock/Dedicated input pins with fanout-independent, low-skew clock networks
 - -PCI 2.1 Compliant I/Os
- Input + logic cell + output delays under 6 ns
- Chip-to-chip operating frequencies up to 110 MHz
- Internal state machine frequencies up to 150 MHz
- Clock skew < 0.5 ns
- Input hysteresis provides high noise immunity
- Built-in scan path permits 100% factory testing of logic and I/O cells and functional testing with Automatic Test Vector Generation (ATVG) software after programming
- 208 pin PQFP pin for pin compatible with the 208 CQFP
- 0.65μ CMOS process with ViaLink programming technology

Device	ASIC Gates	PLD Gates	Package	Max I/O	Qualification Level	SMD 5962-
QL8x12B	1,000	2,000	68CPGA	64	M	
QL12x16B	2,000	4,000	84CPGA	76	M, /883	96836
QL16x24B	4,000	7,000	144CPGA	122	M, /883	95599
			160 CQFP	122	M, /883	95599
QL24x32B	8,000	14,000	208CQFP	180	M, /883	96837
			208PQFP	180	M	

M = Military Temperature (-55 to +125 degrees C)
/883 = MIL-STD-883 qualified

TABLE 1: Selector Table



Military 5.0V pASIC 1 Family

PRODUCT SUMMARY

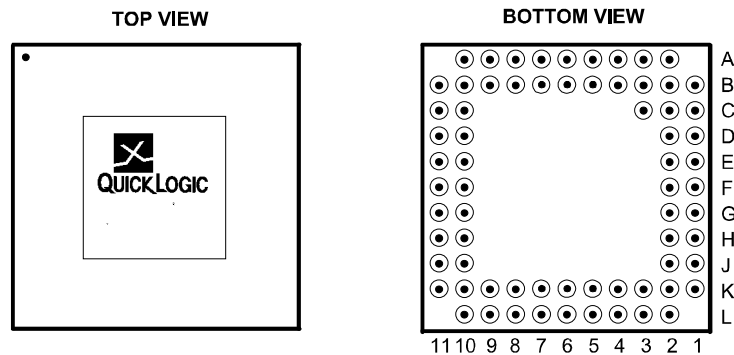
The pASIC 1 Family is a very-high-speed CMOS user-programmable ASIC devices. The 768 logic cell field-programmable gate array (FPGA) features 22,000 usable PLD gates of high-performance general-purpose logic in a 208-pin PQFP and CQFP package.

Low-impedance, metal-to-metal, ViaLink interconnect technology provides nonvolatile custom logic capable of operating above 150 MHz. Logic cell delays under 2 ns, combined with input delays of under 1.5 ns and output delays under 3 ns, permit

high-density programmable devices to be used with today's fastest microprocessors and DSPs.

Designs can be entered using QuickLogic's QuickWorks Toolkit or most popular third-party CAE tools. QuickWorks combines Verilog/VHDL design entry and simulation tools with device-specific place & route and programming software. Ample on-chip routing channels allow fast, fully automatic place and route of designs using up to 100% of the logic and I/O cells, while maintaining fixed pin-outs.

PINOUT DIAGRAM 68-PIN CPGA

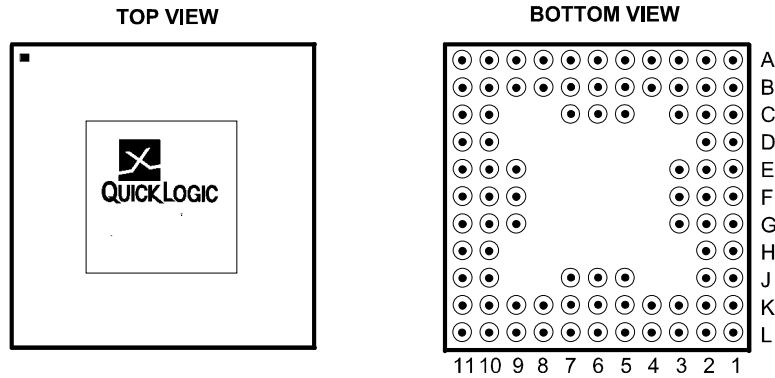


PIN	FUNC	PIN	FUNC	PIN	FUNC	PIN	FUNC
B10	IO	B2	IO	K2	IO	K10	IO
A10	IO	B1	IO	L2	IO	K11	IO
B9	IO	C2	IO	K3	IO	J10	IO
A9	IO	C1	IO	L3	IO	J11	IO
B8	IO	D2	IO	K4	IO	H10	IO
A8	IO	D1	IO	L4	IO	H11	IO
B7	I/(SCLK)	E2	IO	K5	I/(SI)	G10	IO
A7	I/CLK/(SM)	E1	IO	L5	I/CLK	G11	IO
B6	VCC	F2	GND	K6	VCC	F10	GND
A6	I	F1	IO	L6	I	F11	IO
B5	I	G2	IO	K7	I/(SO)	E10	IO
A5	IO	G1	IO	L7	IO	E11	IO
B4	IO	H2	IO	K8	IO	D10	IO
A4	IO	H1	IO	L8	IO	D11	IO
B3	IO	J2	IO	K9	IO	C10	IO
A3	IO	J1	IO	L9	IO	C11	IO
A2	IO	K1	IO	L10	IO	B11	IO

TABLE 2: CPGA 68 Function/Connector Pin Table

Military 5.0V pASIC 1 Family

PINOUT DIAGRAM 84-PIN CPGA

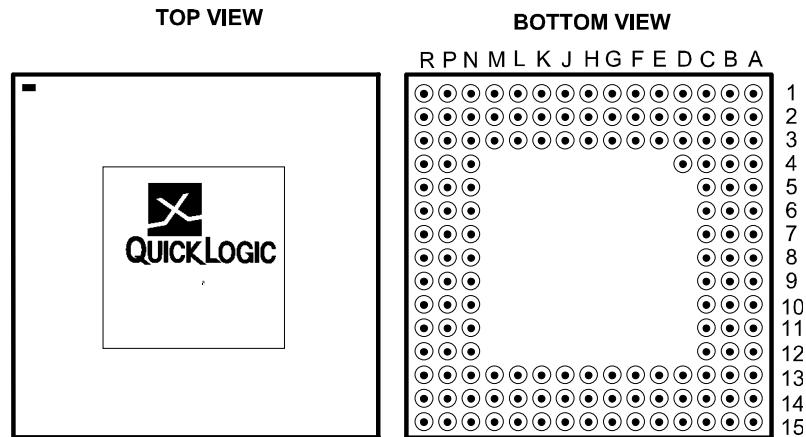


PIN	FUNC	PIN	FUNC	PIN	FUNC	PIN	FUNC
B10	IO	B2	IO	K2	IO	K10	IO
B9	IO	C2	IO	K3	IO	J10	IO
A10	IO	B1	IO	L2	IO	K11	IO
A9	IO	C1	IO	L3	IO	J11	IO
B8	IO	D2	IO	K4	IO	H10	IO
A8	IO	D1	IO	L4	IO	H11	IO
A7	IO	E1	IO	L5	IO	G11	IO
C7	GND	E3	GND	J5	GND	G9	GND
A6	IO	E2	IO	L6	IO	G10	IO
B7	I/(SCLK)	F1	IO	K5	I/(SI)	F11	IO
C6	I/CLK/(SM)	F2	IO	J6	I/CLK	F10	IO
B6	I(P)	F3	IO	K6	I	F9	IO
B5	I	G1	IO	K7	I/(SO)	E11	IO
C5	VCC	G3	VCC	J7	VCC	E9	VCC
A5	IO	G2	IO	L7	IO	E10	IO
A4	IO	H1	IO	L8	IO	D11	IO
B4	IO	H2	IO	K8	IO	D10	IO
A3	IO	J1	IO	L9	IO	C11	IO
A2	IO	K1	IO	L10	IO	B11	IO
B3	IO	J2	IO	K9	IO	C10	IO
A1	IO	L1	IO	L11	IO	A11	IO

TABLE 3: CPGA 84 Function/Connector Pin Table

Military 5.0V pASIC 1 Family

PINOUT DIAGRAM 144-PIN CPGA

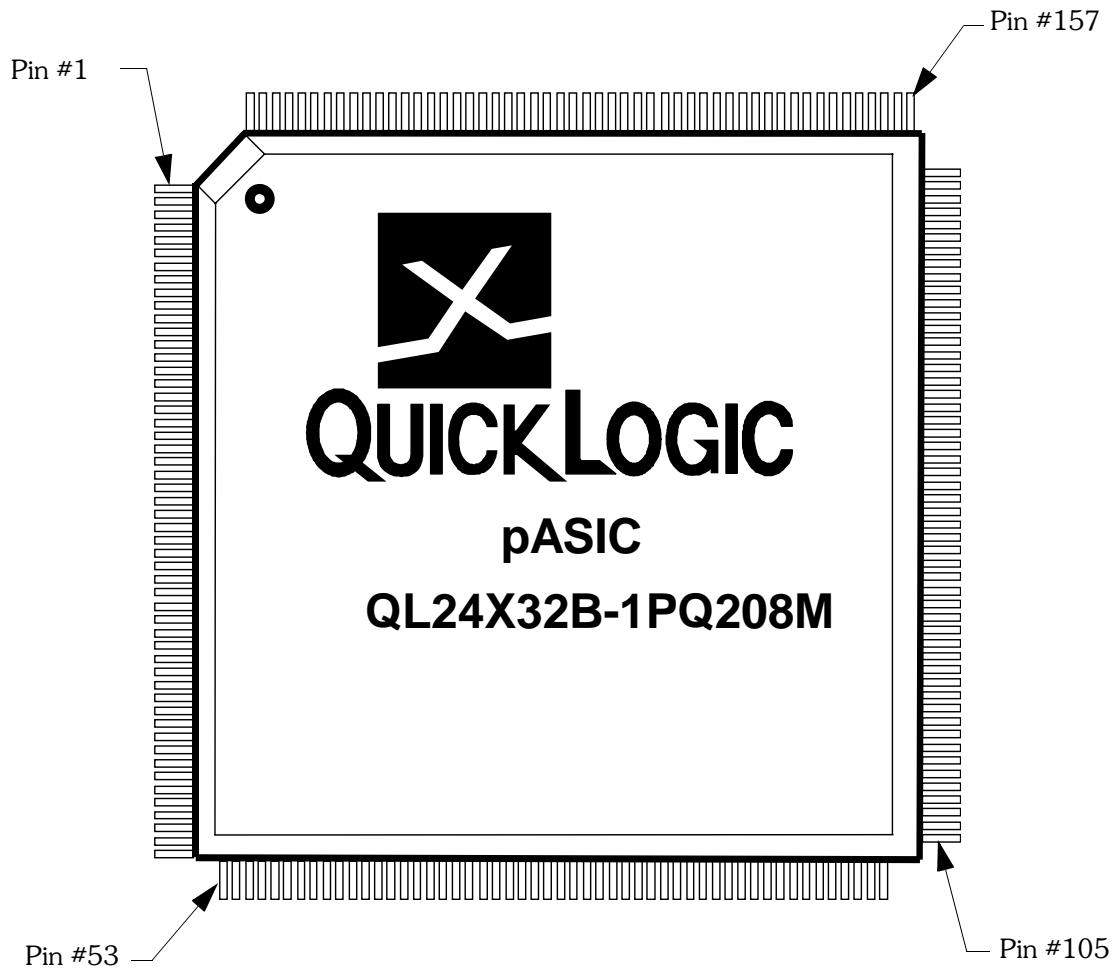


PIN	FUNC	PIN	FUNC	PIN	FUNC	PIN	FUNC
A2	IO	B15	IO	R14	IO	P1	IO
B3	IO	C14	IO	P13	IO	N2	IO
C4	IO	D13	IO	N12	IO	M3	IO
A3	IO	C15	IO	R13	IO	N1	IO
B4	IO	D14	IO	P12	IO	M2	IO
A4	IO	E13	VCC	R12	IO	L3	VCC
C3	VCC	D15	IO	N13	VCC	M1	IO
B5	IO	E14	IO	P11	IO	L2	IO
A5	IO	E15	IO	R11	IO	L1	IO
C6	IO	F13	IO	N10	IO	K3	IO
B6	IO	F14	IO	P10	IO	K2	IO
A6	IO	F15	IO	R10	IO	K1	IO
A7	IO	G15	IO	R9	IO	J1	IO
B7	IO	C13	GND	P9	IO	N3	GND
C5	GND	G14	IO	N11	GND	J2	IO
A8	IO	H15	IO	R8	IO	H1	IO
B8	I/(SCLK)	H14	IO	P8	I/(SI)	H2	IO
C8	I/CLK/(SM)	G13	GND	N8	I/CLK	J3	GND
C7	VCC	H13	IO	N9	VCC	H3	IO
A9	I/(P)	J15	IO	R7	I	G1	IO
B9	I	J14	IO	P7	I/(SO)	G2	IO
C11	VCC	J13	VCC	N5	VCC	G3	VCC
A10	IO	K15	IO	R6	IO	F1	IO
A11	IO	L15	IO	R5	IO	E1	IO
B10	IO	K14	IO	P6	IO	F2	IO

TABLE 4: CPGA 144 Function/Connector Table
(Cont'd on next page)

Military 5.0V pASIC 1 Family

PINOUT DIAGRAM 208-PIN CPGA



Military 5.0V pASIC 1 Family

PQFP/CQFP 208 FUNCTION/CONNECTOR TABLE

PIN	FUN	PIN	FUN	PIN	FUN	PIN	FUN	PIN	FUN	PIN	FUN	PIN	FUN	PIN	FUN
1	I/O	27	VCC	53	I/O	79	I/O	105	I/O	131	VCC	157	I/O	183	I/O
2	I/O	28	I/P	54	I/O	80	I/O	106	I/O	132	I	158	I/O	184	I/O
3	I/O	29	I	55	I/O	81	I/O	107	I/O	133	I/SO	159	I/O	185	I/O
4	I/O	30	VCC	56	I/O	82	I/O	108	I/O	134	VCC	160	I/O	186	I/O
5	I/O	31	I/O	57	I/O	83	VCC	109	I/O	135	I/O	161	I/O	187	VCC
6	I/O	32	I/O	58	I/O	84	I/O	110	I/O	136	I/O	162	I/O	188	I/O
7	I/O	33	I/O	59	GND	85	I/O	111	I/O	137	I/O	163	GND	189	I/O
8	I/O	34	I/O	60	I/O	86	I/O	112	I/O	138	I/O	164	I/O	190	I/O
9	I/O	35	I/O	61	VCC	87	I/O	113	I/O	139	I/O	165	VCC	191	I/O
10	VCC	36	I/O	62	I/O	88	I/O	114	VCC	140	I/O	166	I/O	192	I/O
11	I/O	37	I/O	63	I/O	89	I/O	115	I/O	141	I/O	167	I/O	193	I/O
12	GND	38	I/O	64	I/O	90	I/O	116	GND	142	I/O	168	I/O	194	I/O
13	I/O	39	I/O	65	I/O	91	I/O	117	I/O	143	I/O	169	I/O	195	I/O
14	I/O	40	I/O	66	I/O	92	I/O	118	I/O	144	I/O	170	I/O	196	I/O
15	I/O	41	VCC	67	I/O	93	I/O	119	I/O	145	VCC	171	I/O	197	I/O
16	I/O	42	I/O	68	I/O	94	I/O	120	I/O	146	I/O	172	I/O	198	I/O
17	I/O	43	GND	69	I/O	95	GND	121	I/O	147	GND	173	I/O	199	GND
18	I/O	44	I/O	70	I/O	96	I/O	122	I/O	148	I/O	174	I/O	200	I/O
19	I/O	45	I/O	71	I/O	97	VCC	123	I/O	149	I/O	175	I/O	201	VCC
20	I/O	46	I/O	72	I/O	98	I/O	124	I/O	150	I/O	176	I/O	202	I/O
21	I/O	47	I/O	73	GND	99	I/O	125	I/O	151	I/O	177	GND	203	I/O
22	I/O	48	I/O	74	I/O	100	I/O	126	I/O	152	I/O	178	I/O	204	I/O
23	GND	49	I/O	75	I/O	101	I/O	127	GND	153	I/O	179	I/O	205	I/O
24	I/O	50	I/O	76	I/O	102	I/O	128	I/O	154	I/O	180	I/O	206	I/O
25	I/Sck	51	I/O	77	I/O	103	I/O	129	I/SI	155	I/O	181	I/O	207	I/O
26	I/Clk	52	I/O	78	GND	104	I/O	130	I/Clk	156	I/O	182	GND	208	I/O

Military 5.0V pASIC 1 Family

ABSOLUTE MAXIMUM RATINGS

Supply Voltage	-0.5 to 7.0V	Latch-up Immunity	±200 mA
Input Voltage.....	-0.5 to VCC +0.5V	Storage Temperature	-65°C to +150°C
ESD Pad Protection.....	±2000V	Lead Temperature	300°C
DC Input Current	±20 mA		

5 Volt OPERATING RANGE

Symbol	Parameter	Military		Unit
		Min	Max	
VCC	Supply Voltage	4.5	5.5	V
TA	Ambient Temperature	-55		°C
TC	Case Temperature		125	°C
K	Delay Factor	-0 Speed Grade	0.39	1.82
		-1 Speed Grade	0.39	1.56

DC CHARACTERISTICS over 5V operating range

Symbol	Parameter	Conditions	Min	Max	Unit
VIH	Input HIGH Voltage		2.0		V
VIL	Input LOW Voltage			0.8	V
VOH	Output HIGH Voltage	IOH = -4 mA	3.7		V
		IOH = 16 mA	2.4		V
		IOH = -10 µA	VCC-0.1		V
VOL	Output LOW Voltage	IOL = 8 mA		0.4	V
		IOL = 10 µA		0.1	V
II	Input Leakage Current	VI = VCC or GND	-10	10	µA
IOZ	3-State Output Leakage Current	VI = VCC or GND	-10	10	µA
CI	Input Capacitance [1]			10	pF
IOS	Output Short Circuit Current [2]	VO = GND	-10	-90	mA
		VO = VCC	40	160	mA
ICC	D.C. Supply Current [3]	VI, VIO = VCC or GND		20	mA

Notes:

- [1] Capacitance is sample tested only. CI = 20 pF max on I/(SI).
- [2] Only one output at a time. Duration should not exceed 30 seconds.
- [3] Maximum Icc for military grade is 20 mA. For AC conditions use the formula described in the databook, Section 9 - Power vs Operating Frequency.
- [4] Stated timing for worst case Propagation Delay over process variation at VCC = 5.0V and TA = 25°C. Multiply by the appropriate Delay Factor, K, for speed grade, voltage and temperature settings as specified in the Operating Range.
- [5] These limits are derived from a representative selection of the slowest paths through the pASIC logic cell including net delays. Worst case delay values for specific paths should be determined from timing analysis of your particular design.

Military 5.0V pASIC 1 Family

QL8x12B

AC CHARACTERISTICS at VCC = 5V, TA = 25°C (K = 1.00)

Logic Cell

Symbol	Parameter	Propagation Delays (ns)				
		Fanout				
		1	2	3	4	8
tPD	Combinatorial Delay [5]	1.7	2.1	2.6	3.0	4.8
tSU	Setup Time [5]	2.1	2.1	2.1	2.1	2.1
tH	Hold Time	0.0	0.0	0.0	0.0	0.0
tCLK	Clock to Q Delay	1.0	1.5	1.9	2.3	4.2
tCWHI	Clock High Time	2.0	2.0	2.0	2.0	2.0
tCWLO	Clock Low Time	2.0	2.0	2.0	2.0	2.0
tSET	Set Delay	1.7	2.1	2.6	3.0	4.8
tRESET	Reset Delay	1.5	1.8	2.2	2.5	3.9
tSW	Set Width	1.9	1.9	1.9	1.9	1.9
tRW	Reset Width	1.8	1.8	1.8	1.8	1.8

Input Cells

Symbol	Parameter	Propagation Delays (ns) [4]					
		1	2	3	4	6	8
tIN	High Drive Input Delay [6]	2.1	2.2	2.3	2.4	2.6	2.9
tINI	High Drive Input, Inverting Delay [6]	2.1	2.2	2.3	2.5	2.8	3.1
tIO	Input Delay (bidirectional pad)	1.4	1.8	2.2	2.6	3.4	4.2
tGCK	Clock Buffer Delay [7]	2.7	2.7	2.8	2.9	3.0	
tGCKHI	Clock Buffer Min High [7]	2.0	2.0	2.0	2.0	2.0	
tGCKLO	Clock Buffer Min Low [7]	2.0	2.0	2.0	2.0	2.0	

Output Cell

Symbol	Parameter	Propagation Delays (ns) [4]				
		Output Load Capacitance (pF)				
		30	50	75	100	150
tOUTLH	Output Delay Low to High	2.7	3.4	4.2	5.0	6.7
tOUTH	Output Delay High to Low	2.8	3.7	4.7	5.6	7.6
tPZH	Output Delay Tri-state to High	4.0	4.9	6.1	7.3	9.7
tPZL	Output Delay Tri-state to Low	3.6	4.2	5.0	5.8	7.3
tPHZ	Output Delay High to Tri-state [8]	2.9				
tPLZ	Output Delay Low to Tri-state [8]	3.3				

Notes:

[6] See High Drive Buffer Table for more information.

[7] Clock buffer fanout refers to the maximum number of flip flops per half column. The number of half columns used does not affect clock buffer delay.

[8] The following loads are used for tPXZ:

Military 5.0V pASIC 1 Family

High Drive Buffer

Symbol	Parameter	Clock Drivers Wired Together	Propagation Delays (ns) [4]				
			Fanout				
			12	24	48	72	96
tIN	High Drive Input Delay	1	4.0	4.9			
		2		3.5	5.0		
		3			4.0	4.8	5.6
		4				4.1	4.8
tINI	High Drive Input, Inverting Delay	1	4.2	5.1			
		2		3.7	5.2		
		3			4.2	5.0	5.8
		4				4.3	5.0

[4] Stated timing for worst case Propagation Delay over process variation at VCC = 5.0V and TA = 25°C. Multiply by the appropriate Delay Factor, K, for speed grade, voltage and temperature settings as specified in the Operating Range.

Military 5.0V pASIC 1 Family

QL12x16B

AC CHARACTERISTICS at VCC = 5V, TA = 25°C (K = 1.00)

Logic Cell

Symbol	Parameter	Propagation Delays (ns)				
		Fanout				
		1	2	3	4	8
tPD	Combinatorial Delay [5]	1.7	2.2	2.6	3.2	5.2
tSU	Setup Time [5]	2.1	2.1	2.1	2.1	2.1
tH	Hold Time	0.0	0.0	0.0	0.0	0.0
tCLK	Clock to Q Delay	1.0	1.5	1.9	2.5	4.6
tCWHI	Clock High Time	2.0	2.0	2.0	2.0	2.0
tCWLO	Clock Low Time	2.0	2.0	2.0	2.0	2.0
tSET	Set Delay	1.7	2.1	2.6	3.2	5.2
tRESET	Reset Delay	1.5	1.9	2.2	2.7	4.3
tSW	Set Width	1.9	1.9	1.9	1.9	1.9
tRW	Reset Width	1.8	1.8	1.8	1.8	1.8

Input Cells

Symbol	Parameter	Propagation Delays (ns) [4]					
		1	2	3	4	6	8
tIN	High Drive Input Delay [6]	2.4	2.5	2.6	2.7	3.0	3.3
tINI	High Drive Input, Inverting Delay [6]	2.5	2.6	2.7	2.8	3.1	3.4
tIO	Input Delay (bidirectional pad)	1.4	1.9	2.2	2.8	3.7	4.6
tGCK	Clock Buffer Delay [7]	2.7	2.8	2.8	2.9	2.9	3.0
tGCKHI	Clock Buffer Min High [7]	2.0	2.0	2.0	2.0	2.0	2.0
tGCKLO	Clock Buffer Min Low [7]	2.0	2.0	2.0	2.0	2.0	2.0

Output Cell

Symbol	Parameter	Propagation Delays (ns) [4]				
		Output Load Capacitance (pF)				
		30	50	75	100	150
tOUTLH	Output Delay Low to High	2.7	3.4	4.2	5.0	6.7
tOUTHHL	Output Delay High to Low	2.8	3.7	4.7	5.6	7.6
tPZH	Output Delay Tri-state to High	4.0	4.9	6.1	7.3	9.7
tPZL	Output Delay Tri-state to Low	3.6	4.2	5.0	5.8	7.3
tPHZ	Output Delay High to Tri-state [8]	2.9				
tPLZ	Output Delay Low to Tri-state [8]	3.3				

Notes:

[6] See High Drive Buffer Table for more information.

[7] Clock buffer fanout refers to the maximum number of flip flops per half column. The number of half columns used does not affect clock buffer delay.

[8] The following loads are used for tPXZ:

Military 5.0V pASIC 1 Family

High Drive Buffer

Symbol	Parameter	Clock Drivers Wired Together	Propagation Delays (ns) [4]				
			Fanout				
			12	24	48	72	96
tIN	High Drive Input Delay	1	4.5	5.4			
		2		3.9	5.6		
		3			4.5	5.3	6.3
		4				4.6	5.3
tINI	High Drive Input, Inverting Delay	1	4.7	5.6			
		2		4.0	5.8		
		3			4.6	5.5	6.4
		4				4.8	5.5

[4] Stated timing for worst case Propagation Delay over process variation at VCC = 5.0V and TA = 25°C. Multiply by the appropriate Delay Factor, K, for speed grade, voltage and temperature settings as specified in the Operating Range.

Military 5.0V pASIC 1 Family

QL16x24B

AC CHARACTERISTICS at VCC = 5V, TA = 25°C (K = 1.00)

Logic Cell

Symbol	Parameter	Propagation Delays (ns)				
		Fanout				
		1	2	3	4	8
tPD	Combinatorial Delay [5]	1.7	2.2	2.6	3.2	5.3
tSU	Setup Time [5]	2.1	2.1	2.1	2.1	2.1
tH	Hold Time	0.0	0.0	0.0	0.0	0.0
tCLK	Clock to Q Delay	1.0	1.5	1.9	2.6	4.7
tCWHI	Clock High Time	2.0	2.0	2.0	2.0	2.0
tCWLO	Clock Low Time	2.0	2.0	2.0	2.0	2.0
tSET	Set Delay	1.7	2.2	2.6	3.2	5.3
tRESET	Reset Delay	1.5	1.9	2.2	2.7	4.4
tSW	Set Width	1.9	1.9	1.9	1.9	1.9
tRW	Reset Width	1.8	1.8	1.8	1.8	1.8

Input Cells

Symbol	Parameter	Propagation Delays (ns) [4]					
		1	2	3	4	6	8
tIN	High Drive Input Delay [6]	2.8	2.9	3.0	3.1	4.0	5.3
tINI	High Drive Input, Inverting Delay [6]	3.0	3.1	3.2	3.3	4.1	5.7
tIO	Input Delay (bidirectional pad)	1.4	1.9	2.2	2.9	4.7	6.5
tGCK	Clock Buffer Delay [7]	2.7	2.8	2.9	3.0	3.1	3.3
tGCKHI	Clock Buffer Min High [7]	2.0	2.0	2.0	2.0	2.0	2.0
tGCKLO	Clock Buffer Min Low [7]	2.0	2.0	2.0	2.0	2.0	2.0

Output Cell

Symbol	Parameter	Propagation Delays (ns) [4]				
		Output Load Capacitance (pF)				
		30	50	75	100	150
tOUTLH	Output Delay Low to High	2.7	3.4	4.2	5.0	6.7
tOUTH	Output Delay High to Low	2.8	3.7	4.7	5.6	7.6
tPZH	Output Delay Tri-state to High	4.0	4.9	6.1	7.3	9.7
tPZL	Output Delay Tri-state to Low	3.6	4.2	5.0	5.8	7.3
tPHZ	Output Delay High to Tri-state [8]	2.9				
tPLZ	Output Delay Low to Tri-state [8]	3.3				

Notes:

[6] See High Drive Buffer Table for more information.

[7] Clock buffer fanout refers to the maximum number of flip flops per half column. The number of half columns used does not affect clock buffer delay.

[8] The following loads are used for tPXZ:

Military 5.0V pASIC 1 Family

High Drive Buffer

Symbol	Parameter	Clock Drivers Wired Together	Propagation Delays (ns) [4]				
			Fanout				
			12	24	48	72	96
tIN	High Drive Input Delay	1	5.3	6.7			
		2		4.5	6.6		
		3			5.3	6.2	7.2
		4				5.4	6.2
tNI	High Drive Input, Inverting Delay	1	5.7	7.2			
		2		4.6	6.8		
		3			5.5	6.4	7.4
		4				5.6	6.4

[4] Stated timing for worst case Propagation Delay over process variation at VCC = 5.0V and TA = 25°C. Multiply by the appropriate Delay Factor, K, for speed grade, voltage and temperature settings as specified in the Operating Range.

Military 5.0V pASIC 1 Family

QL24x32B

AC CHARACTERISTICS at VCC = 5V, TA = 25°C (K = 1.00)

Logic Cell

Symbol	Parameter	Propagation Delays (ns)				
		Fanout				
		1	2	3	4	8
tPD	Combinatorial Delay [5]	1.7	2.1	2.7	3.3	5.5
tSU	Setup Time [5]	2.1	2.1	2.1	2.1	2.1
tH	Hold Time	0.0	0.0	0.0	0.0	0.0
tCLK	Clock to Q Delay	1.0	1.5	1.9	2.7	4.9
tCWHI	Clock High Time	2.0	2.0	2.0	2.0	2.0
tCWLO	Clock Low Time	2.0	2.0	2.0	2.0	2.0
tSET	Set Delay	1.7	2.2	2.7	3.3	5.5
tRESET	Reset Delay	1.5	1.9	2.3	2.8	4.6
tSW	Set Width	1.9	1.9	1.9	1.9	1.9
tRW	Reset Width	1.8	1.8	1.8	1.8	1.8

Input Cells

Symbol	Parameter	Propagation Delays (ns) [4]						
		1	2	3	4	8	12	16
tIN	High Drive Input Delay [6]	3.1	3.2	3.3	3.4	4.4	5.8	6.5
tINI	High Drive Input, Inverting Delay [6]	3.3	3.4	3.5	3.6	4.6	6.0	6.7
tIO	Input Delay (bidirectional pad)	1.4	1.9	2.3	3.0	4.8	6.7	8.5
tGCK	Clock Buffer Delay [7]	2.7	2.8	2.9	3.0	3.1	3.3	3.4
tGCKHI	Clock Buffer Min High [7]	2.0	2.0	2.0	2.0	2.0	2.0	2.0
tGCKLO	Clock Buffer Min Low [7]	2.0	2.0	2.0	2.0	2.0	2.0	2.0

Output Cell

Symbol	Parameter	Propagation Delays (ns) [4]				
		Output Load Capacitance (pF)				
		30	50	75	100	150
tOUTLH	Output Delay Low to High	2.7	3.3	3.8	4.3	5.4
tOUTH	Output Delay High to Low	2.8	3.6	4.5	5.3	6.9
tPZH	Output Delay Tri-state to High	2.1	2.6	3.1	3.7	4.8
tPZL	Output Delay Tri-state to Low	2.6	3.3	4.1	4.9	6.5
tPHZ	Output Delay High to Tri-state [8]	2.9				
tPLZ	Output Delay Low to Tri-state [8]	3.3				

Notes:

[6] See High Drive Buffer Table for more information.

[7] Clock buffer fanout refers to the maximum number of flip flops per half column. The number of half columns used does not affect clock buffer delay.

[8] The following loads are used for tPXZ:

Military 5.0V pASIC 1 Family

High Drive Buffer

Symbol	Parameter	Clock Drivers Wired Together	Propagation Delays (ns) [4]				
			Fanout				
			12	24	48	72	96
tIN	High Drive Input Delay	1	5.8	7.2			
		2		5.0	7.1		
		3			5.8	6.7	7.7
		4				5.9	6.8
tINI	High Drive Input, Inverting Delay	1	6.0	7.4			
		2		5.2	7.3		
		3			6.0	6.9	7.9
		4				6.1	7.0

[4] Stated timing for worst case Propagation Delay over process variation at VCC = 5.0V and TA = 25°C. Multiply by the appropriate Delay Factor, K, for speed grade, voltage and temperature settings as specified in the Operating Range.

AC Performance

Propagation delays depend on routing, fanout, load capacitance, supply voltage, junction temperature, and process variation. The AC Characteristics are a design guide to provide initial timing estimates at nominal conditions. Worst case estimates are obtained when nominal propagation delays are multiplied by the appropriate Delay Factor, K, as specified in the Delay Factor table (Operating Range). The

effects of voltage and temperature variation are illustrated in the graphs on the following pages, K Factor versus Voltage and Temperature. The pASIC Development Tools incorporate data sheet AC Characteristics into the QDIF database for pre-place-and-route timing analysis. The SpDE Delay Modeler extracts specific timing parameters for precise path analysis or simulation results following place and route.

ORDERING INFORMATION

